



FMMT734

100V PNP DARLINGTON TRANSISTOR IN SOT23

Features

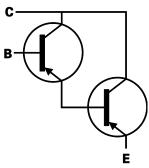
- $BV_{CEO} > -100V$
- I_C = -800mA High Continuous Collector Current
- Darlington Transistor h_{FE} > 20k @ 100mA for High Gain
- High Gain Hold-Up to 5A
- 625mW Power Dissipation
- Complementary Darlington NPN Type: FMMT634
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

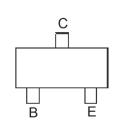
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight 0.008 grams (Approximate)











Top View Pin-Out

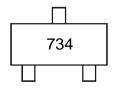
Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
FMMT734TA	AEC-Q101	734	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



734 = Product Type Marking Code

1 of 7 FMMT734 November 2015 Document Number: DS33121 Rev. 2 - 2 © Diodes Incorporated



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-100	V
Collector-Emitter Voltage	$V_{\sf CEO}$	-100	V
Emitter-Base Voltage	V_{EBO}	-12	V
Continuous Collector Current	Ic	-800	mA
Peak Pulse Current	I _{CM}	-5	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	625	mW
Power Dissipation (Note 6)	P _D	806	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	155	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R ₀ JL	194	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	2,000	V	1C
Electrostatic Discharge - Machine Model	ESD MM	200	V	Α

Notes:

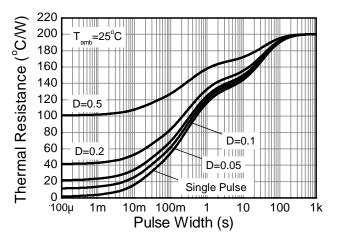
- 5. For a device surface mounted on 25mm X 25mm FR-4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 6. Same as note 5, except the device is measured at t ≤ 5 sec.
 7. Thermal resistance from junction to solder-point (at the end of the collector lead).

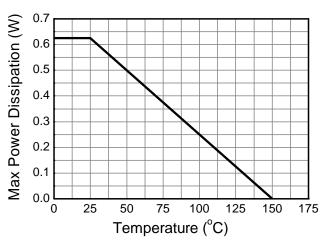
- 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

2 of 7 FMMT734 Document Number: DS33121 Rev. 2 - 2

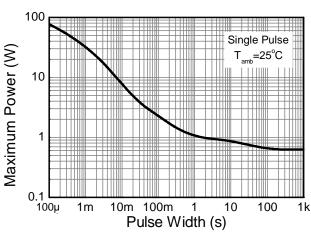


Thermal Characteristics and Derating Information

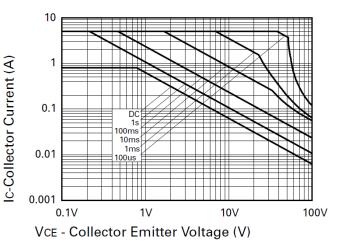




Transient Thermal Impedance



Derating Curve



Pulse Power Dissipation

Safe Operating Area



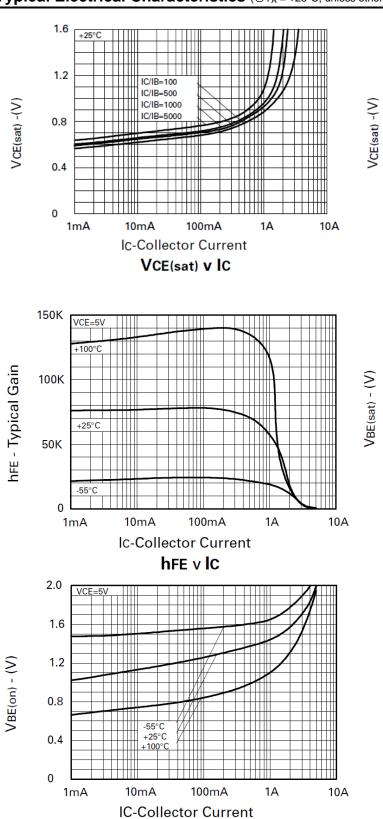
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

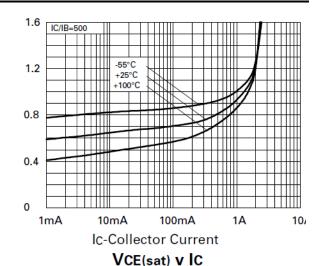
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_CBO	-100	-130	-	V	$I_{C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 9)	BV_CEO	-100	-116	-	V	$I_C = -5mA$
Emitter-Base Breakdown Voltage	BV_{EBO}	-12	-17	-	V	$I_E = -100 \mu A$
Collector Cutoff Current	I _{CBO}	-	-	-10	nA	V _{CB} = -80V
Collector Cutoff Current	I _{CES}	-	-	-200	nA	V _{CES} = -80V
Emitter Cutoff Current	I _{EBO}	-	-	-10	nA	V _{EB} = -7V
ON CHARACTERISTICS (Note 9)						
Static Forward Current Transfer Ratio Collector-Emitter Saturation Voltage	h _{FE}	20,000 15,000 5,000 - -	60,000 60,000 50,000 15,000 150 20,000 -0.68 -0.72 -0.78 -0.86 -0.72 -0.90	- - - - - - -0.75 -0.80 -0.86 -0.97 - -1.05	- V	Ic = -10mA, V _{CE} = -5V Ic = -100mA, V _{CE} = -5V Ic = -1A, V _{CE} = -5V Ic = -2A, V _{CE} = -5V Ic = -5A, V _{CE} = -5V Ic = -1A, V _{CE} = -5V Ic = -100mA, I _B = -1mA Ic = -250mA, I _B = -1mA Ic = -500mA, I _B = -5mA Ic = -800mA, I _B = -5mA Ic = -800mA, I _B = -5mA Ic = -800mA, I _B = -5mA, T _J = +150°C I _C = -1A, I _B = -5mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	-	-1.6	-1.75	V	I _C = -1A, I _B = -5mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	-	-1.3	-1.75	V	I _C = -1A, V _{CE} =-5V
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency	f _T	-	140	-	MHz	$V_{CE} = -10V, I_{C} = -10mA,$ f = 100MHz
Output Capacitance	C_{obo}	-	14	25	pF	V _{CB} = -10V, f = 1MHz
Turn-On Time	t _(on)	-	460	-	ns	I _C =-500mA, V _{CC} =-20V
Turn-Off Time	t _(off)	-	1200	-	ns	I _B =±1mA

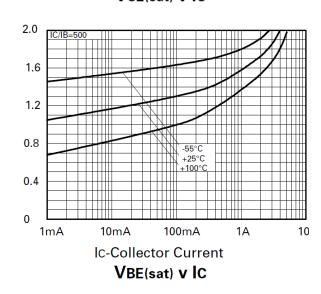
Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)







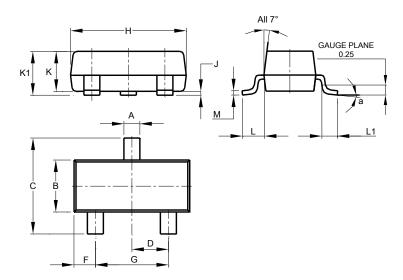
VBE(on) v IC



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SOT23

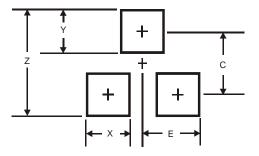


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
M	0.085	0.150	0.110		
а	8°				
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.





Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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7 of 7 FMMT734 November 2015 Document Number: DS33121 Rev. 2 - 2 © Diodes Incorporated

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